

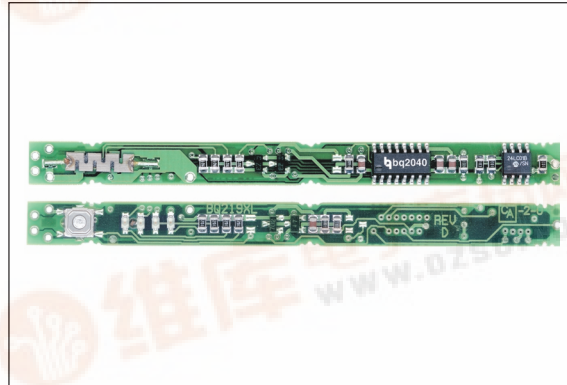


Preliminary **bq219XL**

Smart Battery Module with LEDs

Features

- Complete smart battery solution for NiCd, NiMH, and Li-Ion battery packs
- Based on the bq2092 or bq2040 Gas Gauge IC
- Ideal for DR35 or DR36 type packs
- Narrow board fits in the crevice formed by two adjacent battery packs
- Accurate measurement of available battery capacity
- Designed for battery pack integration:
 - Measures only 3.5 (L) x 0.3 (W) inches
 - Includes Gas Gauge IC, configuration EEPROM, and sense resistor
 - Four onboard state-of-charge LEDs with push-button activation
 - Low operating current for minimal battery drain
- Critical battery information available over two-wire serial port



parameters. The Smart Battery Module uses the onboard sense resistor to track charge and discharge activity of the battery pack. Figure 1 shows how the module connects to the cells.

A module development kit is also available for the bq219XL. The bq219XLB-KT includes one configured module and the following:

- 1) An EV2200-92 or EV2200-40 interface board that allows connection to the serial port of any AT-compatible computer.
- 2) Menu-driven software to display charge/discharge activity and to allow user interface to the Gas Gauge IC and serial EEPROM from any standard Windows 95 or 3.1x PC.

General Description

The bq219XL Smart Battery Module provides a complete solution for the design of intelligent battery packs. The bq219XL uses the SMBus protocol and supports the Smart Battery Data commands in the SMB/SBD specifications. Designed for battery pack integration, the bq219XL combines the bq2092 or bq2040 Gas Gauge IC with a serial EEPROM on a small printed circuit board. The board includes all the necessary components to accurately monitor battery capacity and communicate critical battery parameters to the host system or battery charger. The bq219XL also includes four LEDs. The push-button switch activates the LEDs to show remaining battery capacity in 25% increments.

Contacts are provided on the bq219XL for direct connection to the battery stack (B+, B-) and the two-wire interface (C, D). Please refer to the bq2092 or bq2040 data sheet for specific information on the operation of the Gas Gauge and communication interface.

Unitrode configures the bq219XL based on the information requested in Table 1. The configuration defines the pack voltage, capacity, and chemistry and charge control

Pin Descriptions

B+	BAT+/Battery positive/Pack positive
P-	PACK-/Pack negative
C	SMBC/Communications clock
D	SMBD/Serial data
B-	BAT-/Battery negative
STAT	STAT/No connect



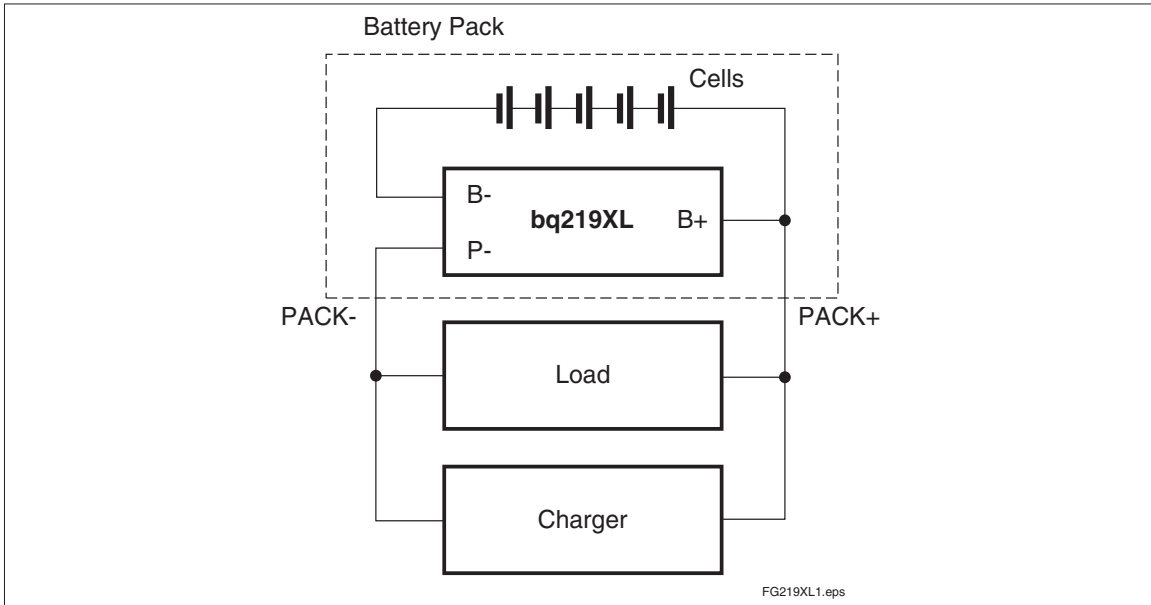
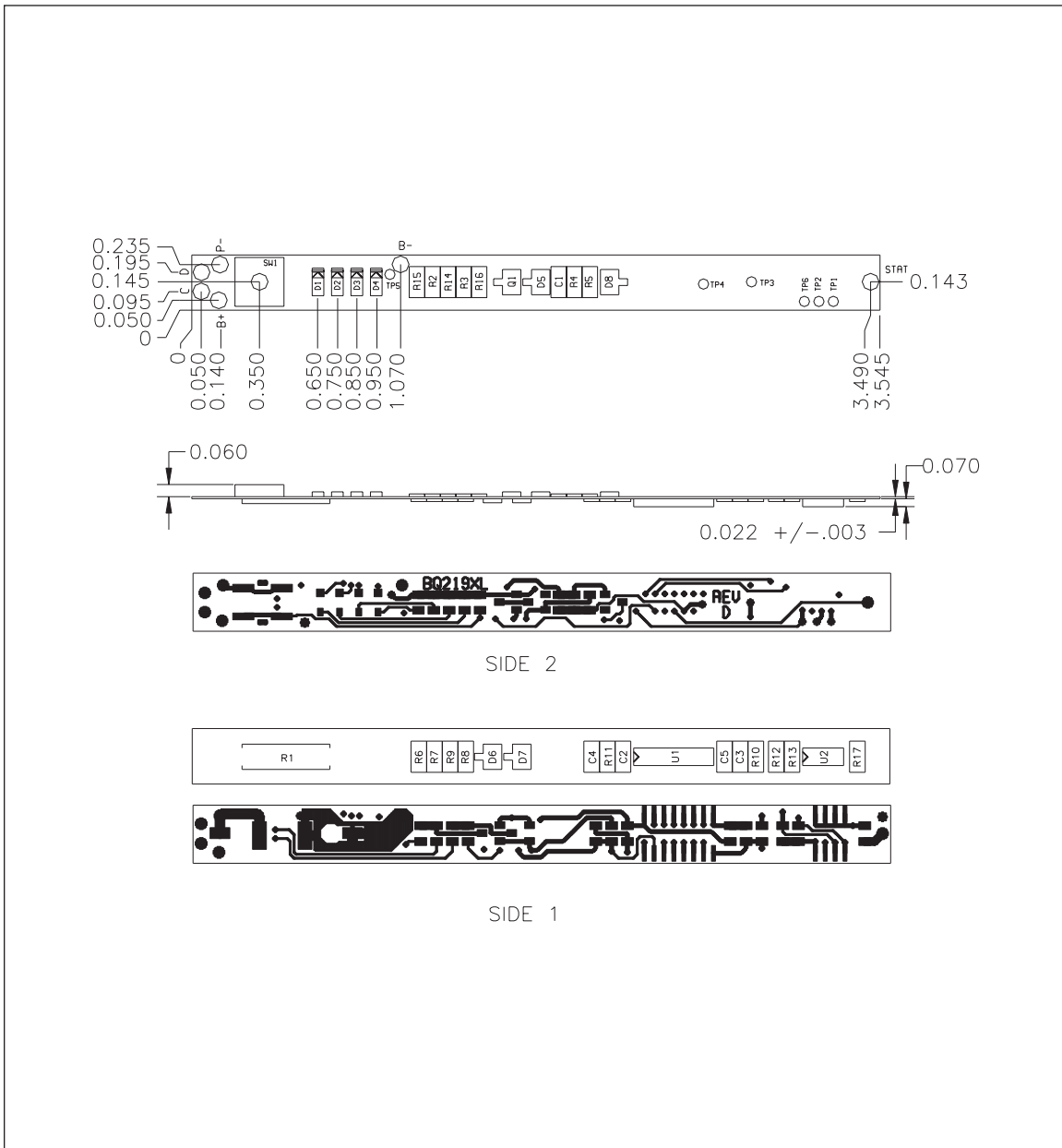


Figure 1. Module Connection Diagram

Table 1. bq219XL Module Configuration

Customer Name: _____			
Contact: _____		Phone: _____	
Address: _____			
Sales Contact: _____		Phone: _____	
Board Configuration			
IC type	_____	bq2040 or bq2092	
LEDs and switch	_____	Yes or No	
Display mode	_____	Relative or Absolute	
Discharge rate (3.0A max.)	Min _____	Avg _____	Max _____
Duration at max. discharge	_____		
Number of series cells	_____		
EEPROM Configuration			Typical Values
			NiMH Li-Ion
Remaining time alarm (min)	_____	Sets the low time alarm level	10 min 10 min
Remaining capacity alarm (mAh)	_____	Sets the low capacity alarm level	C/10 C/10
Charging voltage (mV)	_____	Sets the requested charging voltage	65535 4.1V/cell
Design capacity (mAh)	_____	Defines the battery pack capacity	3000 3600
Design voltage (mV)	_____	Defines the battery pack voltage	12000 10800
Manufacturer date	_____	Battery pack manufacturer date	mm/dd/yy mm/dd/yy
Serial number	_____	Battery pack serial number	0-65535 0-65535
Fast-charging current (mA)	_____	Sets the requested charging current	1C 1C
Maintenance charging current (mA)	_____	Sets the requested maintenance charging current	C/20 0
Li-Ion taper current (mA)	_____	Sets the upper limit for charge termination	NA C/10
Maximum overcharge (mAh)	_____	Sets the maximum amount of overcharge	256mAh 128mAh
Maximum temperature (°C)	_____	Sets the maximum charge temperature	61°C 61°C
$\Delta T/\Delta t$ (°C/min)	_____	Sets the termination rate	3°C/3min 4.6°C/20s
Fast-charge efficiency (%)	_____	Sets the fast-charge efficiency factor	95% 100%
Maintenance charge efficiency (%)	_____	Sets the maintenance charge efficiency factor	80% 100%
Self-discharge rate (%/day)	_____	Sets the battery's self-discharge rate	1.5%/day 0.2%/day
EDV1 (mV)	_____	Sets the initial end-of-discharge warning	1.05V/cell 3.0V/cell
EDVF (mV)	_____	Sets the final end-of-discharge warning	1.0V/cell 2.8V/cell
Hold-off timer for $\Delta T/\Delta t$ (sec.)	_____	Sets the hold off period for $\Delta T/\Delta t$ termination	180s 320s
Manufacturer name	_____	Programs manufacturer's name (11 char. max)	bq bq
Device name	_____	Programs device name (7 char. max)	bq36 bq202
Chemistry	_____	Programs pack's chemistry (5 char. max)	NiMH LION
Manufacturer data	_____	Open field (5 char. max)	2040 2040
FAE Approval: _____	Date: _____		

bq219XL Board



bq219XL *Preliminary*

Ordering Information

bq219XL B - XXX

Customer Code:

Blank = Sample or Pre-production¹

KT = Evaluation system

XXX = Customer-specific; assigned by Unitrode²

Package Option:

B = Board-level product

Device:

Smart Battery Module with LEDs

- Notes:**
1. Requires configuration sheet (see Table 1)
 2. Example production part number: bq219XLB-001

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